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Design **Objectives** 

# Standard LGH Connectors, Series 1/2I, 1/2LI, 1I, 1LI, 2I, 3I and 4I

#### **DESIGN OBJECTIVES**

The product described in this document has not been fully tested to ensure conformance to the requirements outlined below. Therefore Tyco Electronics makes no representation or warranty, express or implied, that the product will comply with these requirements. Further, Tyco Electronics may change these requirements based on the results of additional testing and evaluation. Contact Tyco Electronics Engineering for further details.

## **SCOPE**

#### 1.1. Content

This specification covers performance, tests and quality requirements for the Tyco Electronics LGH standard high voltage 1/2I, 1/2LI, 1I, 1LI, 2I, 3I and 4I series molded end leads and receptacles. These leads and receptacles are designed for commercial, industrial and military type applications requiring operation over wide environments.

#### 1.2. Qualification

When tests are performed on the subject product line, procedures specified in Figure 1 shall be used. All inspections shall be performed using the applicable inspection plan and product drawing.

#### 2. **APPLICABLE DOCUMENTS**

The following documents form a part of this specification to the extent specified herein. Unless otherwise specified, the latest edition of the document applies. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In the event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

# 2.1. Tyco Electronics Documents

- 109 Series: Test Specifications as indicated in Figure 1
- 109-197: Test Specification (AMP Test Specifications vs EIA and IEC Test Methods)
- 114- : Application Specification
- : Qualification Test Report

#### 2.2. Commercial Standard

Electric Connector/Socket Test Procedures Including Environmental Classifications EIA-364:

#### 2.3. Military Standard

MIL-STD-202: Test Me ods For Electronic And Electrical Component Parts

# REQUIREMENTS 3.

#### 3.1. Design and Construction

Product shall be of the design, construction and physical dimensions specified on the applicable product drawing.

**DESIGN OBJECTIVES** 



# 3.2. Materials

Materials used in the construction of this product shall be as specified on the applicable product drawing.

# 3.3. Ratings

Voltage:

10 kilovolts 1/2I: 1/2LI: 15 kilovolts 20 kilovolts 11: 1LI: 25 kilovolts 21: 30 kilovolts 31: 40 kilovolts 41: 50 kilovolts Temperature: -55 to 125°C

# 3.4. Performance and Test Description

Product is designed to meet the electrical, mechanical and environmental performance requirements specified in Figure 1. Unless otherwise specified, all tests shall be performed at ambient environmental conditions per EIA-364.

# 3.5. Test Requirements and Procedures Summary

Test Description	Requirement	Procedure	
Initial examination of product.	Meets requirements of product drawing.	EIA-364-18. Visual and dimensional (C of C) inspection per product drawing.	
Final examination of product.	Meets visual requirements.	EIA-364-18. Visual inspection.	
07	ELECTRICAL		
Contact resistance.	100 milliohms maximum.	EIA-364-6. Measure potential drop of mated specimens at 1 ampere maximum. Calculate resistance. See Figure 3.	
	5000 megohms minimum.	EIA-364-21. Test between contacts of mated lead connector assemblies and ground.	
Withstanding voltage.	Series Test Voltage (kvDC)  1/2I 15  1/2LI 23  1I 30  1LI 38  2I 45  3I 55  4I 60  5 microamperes maximum leakage current. 3 minute hold.	EIA-364-20, Condition I. Test between contacts of mated lead connector assemblies and ground.	

Figure 1 (cont)

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Test Description	Requirement	Procedure			
MECHANICAL					
Vibration, sinusoidal.	No discontinuities of 10 microseconds or longer duration. See Note.	EIA-364-28, Test Condition I. Subject mated specimens to 10-55- 10 Hz traversed in 1 minute with 1.5 mm [.06 in] maximum total excursion. 2 hours in each of 3 mutually perpendicular planes.			
Mechanical shock.	No discontinuities of 1 microsecond or longer duration. See Note.	EIA-364-27, Method H. Subject mated specimens to 30 G's half-sine shock pulses of 11 milliseconds duration. 3 shocks in each direction applied along 3 mutually perpendicular planes, 18 total shocks.			
Durability.	See Note.	EIA-364-9. Mate and unmate gold plated specimens for 500 cycles and tin plated specimens for 50 cycles at a maximum rate of 500 cycles per hour.			
Contact engaging force.	20 ounces maximum.	AMP Spec 109-35.  Measure force necessary to engage using gage 2 to a depth of .19 inch for 1/2I and 1/2LI and .25 inch for 1I, 1LI, 2I, 3I and 4I.  See Figure 4.			
Contact separating force.  No. 100 Separating force.	3 ounces minimum.	AMP Spec 109-35. Size 3 times using gage 2. Then insert gage 1 to depth of .19 inch for 1/2I and 1/2LI and .25 inch for 1I, 1LI, 2I, 3I and 4I and measure force necessary to separate. See Figure 4.			
5	ENVIRONMENTAL				
Thermal shock.	See Note.	EIA-364-32. Subject specimens to 5 cycles between -55 and 125°C.			
Humidity, steady state.  O  Temperature life.	See Note.	EIA-364-31, Method II, Condition A. Subject specimens to 40°C and 90 to 95% RH for 96 hours.			
Temperature life.	See Note.	EIA-364-17, Method A, Test Condition 5, Test Time Condition A. Subject mated specimens to 125°C for 96 hours.			
	Figure 1 (cont)				

Figure 1 (cont)

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Test Description	Requirement	Procedure	
Barometric pressure, temperature cycling.	See Note.	MIL-STD 202, Method 105C, Condition C.	
Hermetic seal.	Leakage rate less than 1 X 10 <sup>-8</sup> cc He/sec. See Note.	MIL-STD 202, Method 112C, Condition C.	

NOTE

Shall meet visual requirements, show no physical damage, and meet requirements of additional tests as specified in the Product Qualification and Requalification Test Sequence shown in Figure

Figure 1 (end)

#### 3.6. Product Qualification and Requalification Test Sequence

	Test Group (a)	
Test or Examination	1	2(c)
	Test Sequence (b)	
Initial examination of product	1,19	1,18
Contact resistance	4,8	5,9
Insulation resistance	2	3
Withstanding voltage	3,11,15	4,13,17
Vibration	9	10
Mechanical shock	10	11
Durabilit	7	8
Contact engaging force	5,17	6
Contact separating force	6,18	7
Therma	14	15
Humidit steady state	12	14
Temperature life	16	
Barometic pressure, temperature cycling	13(d)	
Hermeteseal		2,12,16
Final examination of product	19	18

# NOTE

- (a) See par graph 4.1.A.
  (b) Number indicate sequence in which tests are performed.
- This tes roup is applicable to hermetic seal type receptacles only.
- HiPot is performed at each temperature extreme and reduced barometric pressure, 70000 feet.

Figure 2

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### 4. QUALITY ASSURANCE PROVISIONS

### 4.1. Qualification Testing

### A. Specimen Selection

Specimens shall be prepared in accordance with applicable Instruction Sheets and shall be selected at random from current production. Test group 1 shall consist of 28 lead assemblies and receptacles; 4 each from 1/2I, 1/2LI, LI, 1LI, 2I, 3I and 4I series. Test group 2 shall consist of 14 hermetic seal type receptacles; 2 each from 1/2I, 1/2LI, LI, 1LI, 2I, 3I and 4I series.

# B. Test Sequence

Qualification inspection shall be verified by testing specimens as specified in Figure 2.

### 4.2. Requalification Testing

If changes significantly affecting form, fit or function are made to the product or manufacturing process, product assurance shall coordinate requalification testing, consisting of all or part of the original testing sequence as determined by development/product, quality and reliability engineering.

# 4.3. Acceptance

Acceptance is based on verification that the product meets the requirements of Figure 1. Failures attributed to equipment, test setup or operator deficiencies shall not disqualify the product. If product failure occurs, corrective action shall be taken and specimens resubmitted for qualification. Testing to confirm corrective action is required before resubmittal.

# 4.4. Quality Conformance Inspection

The applicable quality in spection plan shall specify the sampling acceptable quality level to be used. Dimensional and functional requirements shall be in accordance with the applicable product drawing and this specification.

DESIGN OBJECTIVES



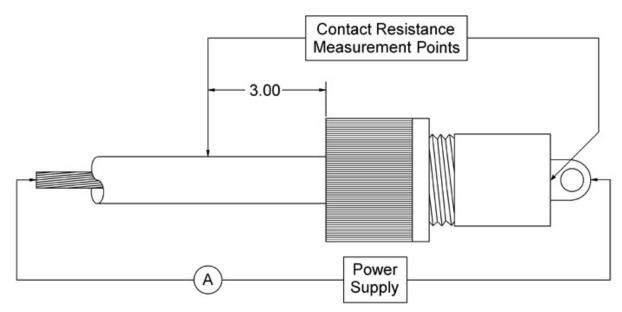


Figure 3
Contact Resistance Measurement Points

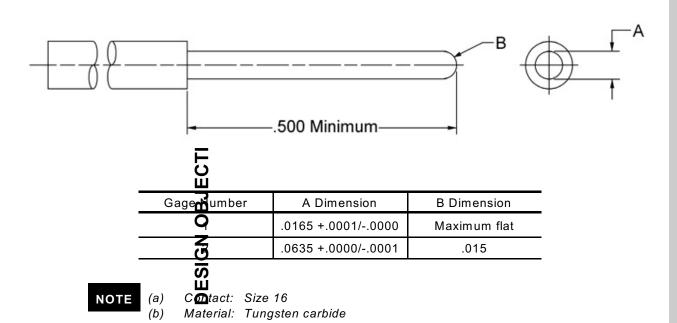


Figure 4
Engaging & Separating Gage

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